May 2015



FSV1045V 10 A, 45 V Ultra-Low VF Schottky Rectifier

Features

- Ultra-Low Forward Voltage Drop:
 0.41 V Typical at 10 A, T_A = 25°C
 - 0.44 V Maximum at 10 A, $T_A = 25^{\circ}C$
- Low Thermal Resistance
- Very Low Profile: Typical Height of 1.1 mm
- RoHS Compliant
- Halogen Free
- Meets MSL 1 per JESD22-A111 Full-Body Solder
 Immersion

Description

The FSV1045V schottky rectifier offers break-through size and performance. The device is optimized for mobile charger applications. It sinks only 18 mA reverse current at high temperature and provides forward voltage drop of 0.18 V at 1 A operating current in a charger design.

All this capability is packed into a small, flat-lead, TO-277 package, optimized for space-constrained applications. The FSV1045V supports a typical Z height of 1.1 mm. It is RoHS compliant and halogen free. It is also qualified for a wave soldering process.

Applications

- Mobile Charger
- Solar Panel
- Reverse Polarity Protection





Ordering Information

Part Number	Top Mark	Package	Packing Method
FSV1045V	FSV1045V	TO-277 3L	Tape and Reel

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{RRM}	Peak Repetitive Reverse Voltage	45	V
V _{RWM}	Working Peak Reverse Voltage	45	V
V _{RMS}	RMS Reverse Voltage	32	V
V _R	DC Blocking Voltage	45	V
Ι _Ο	Average Rectified Output Current ⁽²⁾ $T_L = 105^{\circ}C$	10	A
I _{FSM}	Non-Repetitive Peak Forward Surge Current ⁽³⁾	300	A
CJ	Typical Junction Capacitance $V_R = 4 V, 1 MHz$	820	pF
Т _Ј	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

Notes:

1. All tests conducted at $T_A = T_J = 25^{\circ}C$ unless otherwise noted.

2. Mounted on 30 mm x 30 mm FR4 PCB.

3. Pulse condition: 8.3 ms single half-sine wave. Test method is compliant with MIL standard. (MIL-STD-750E)

Thermal Characteristics⁽⁴⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Minimum Land Pattern	Maximum Land Pattern	Unit
$R_{ extsf{ heta}JA}$	Junction-to-Ambient Thermal Resistance	40	°C/W	
¥j∟	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Anode	15	12	°C / M
	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Cathode	6	5	0/11

Note:

4. The thermal resistances (R_{θJA} & ψ_{JL}) are characterized with device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size: 76.2 x 114.3 mm. Minimum land pattern size: 4.9 x 4.8 mm (big pattern, x1), 1.4 x 1.52 mm (small pattern, x2). Maximum land pattern size: 30 x 30 mm (pattern, x2). Force line trace size = 55 mils, sense line trace size = 4 mils.





Figure 1. Minimum Land Pattern of 2 oz Copper



Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
V _{BR}	Breakdown Voltage	I _T = 500 μA		45			V
		I _F = 1 A	T _A = 25°C		0.28		V
V _F	Forward Voltage Drop	I _F = 10 A			0.41	0.44	
		I _F = 1 A	T _A = 125°C		0.18		
		I _F = 10 A			0.36	0.39	
I _R	Maximum Leakage	V = V _{RWM}	$T_A = 25^{\circ}C$		0.065	0.220	mA
			T _A = 125°C		19	32	



© 2014 Fairchild Semiconductor Corporation FSV1045V Rev. 1.1

FSV1045V — 10 A, 45 V Ultra-Low VF Schottky Rectifier



FAIRCHILD. TRADEMARKS The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks. AccuPower™ F-PFS™ **OPTOPLANAR[®]** AttitudeEngine™ FRFET® Awinda[®] AX-CAP[®]* Global Power Resource SM ® TinyBoost[®] TinyBuck GreenBridge™ Power Supply WebDesigner™ BitSiC™ TinyCalc™ Green FPS™ PowerTrench Build it Now™ TinyLogic® Green FPS™ e-Series™ PowerXS™ CorePI US™ Gmax™ TINYOPTO™ Programmable Active Droop™ CorePOWER™ TinyPower™ GTO™ QFĔT CROSSVOLT™ TinyPWM™ IntelliMAX™ QS™ TinvWire™ CTL™ Quiet Series™ Current Transfer Logic™ TranSiC™ Making Small Speakers Sound Louder RapidConfigure™ **DEUXPEED**[®] and Better TriFault Detect™ Dual Cool™ TRUECURRENT®* MegaBuck™ Saving our world, 1mW/W/kW at a time™ **EcoSPARK[®]** MICROCOUPLER™ μSerDes™ SignalWise™ EfficientMax™ MicroFET™ SmartMax™ ESBC™ MicroPak™ SMART START™ MicroPak2™ F UHC Solutions for Your Success™ MillerDrive™ Ultra FRFET™ Fairchild® SPM[®] MotionMax™ UniFET™ Fairchild Semiconductor® STEALTH™ MotionGrid® VCX™ FACT Quiet Series™ SuperFET[®] MTi[®] VisualMax™ FACT[®] FAST[®] SuperSOT™-3 MTx® VoltagePlus™ SuperSOT™-6 MVN® XS™ FastvCore™ SuperSOT™-8 mWSaver® Xsens™ FETBench™ SupreMOS[®] OptoHiT™ 仙童™ **FPS**TM SyncFET™ **OPTOLOGIC[®]** Sync-Lock™ * Trademarks of System General Corporation, used under license by Fairchild Semiconductor. DISCLAIMER FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE DSEMI.COM. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS. LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein: 1. Life support devices or systems are devices or systems which, (a) are 2. A critical component in any component of a life support, device, or intended for surgical implant into the body or (b) support or sustain system whose failure to perform can be reasonably expected to life, and (c) whose failure to perform when properly used in cause the failure of the life support device or system, or to affect its accordance with instructions for use provided in the labeling, can be safety or effectiveness. reasonably expected to result in a significant injury of the user. ANTI-COUNTERFEITING POLICY Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support. Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full reaceability and or Authorized Distributors will standards for handling and storage and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

PF	so	DUCT	STA	TUS	DEF	ΙΝΙΤΙ	ONS
_	~						

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		
	·	Rev. 174		